

Special Issue

Chemical and Physical Properties in Food Processing: Second Edition

Message from the Guest Editor

Food production involves various processes that affect the physical, chemical, and microbiological properties of the food produced. The application of these various processes affects the food in terms of stability, texture, taste, colour, etc., but also acquires properties that make the new food suitable for different populations with specific needs or health problems. We are pleased to invite you to contribute to this Special Issue which will be dedicated to presenting methodologies applied in food production or food modification, and how these processes affect the physical, chemical, and microbiological properties of foods. Original research articles, short communications, or review articles could be published in this Special Issue.

Guest Editor

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Deadline for manuscript submissions

closed (20 July 2025)



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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

Editor-in-Chief

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